# OPTICAL MEMS IN COMMUNICATION AND SENSING:

Fabrication, design and scaling of optical microsystems

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## Course Outline:

### A. Introduction and Overview

- 1. Introduction to Optical MEMS Opportunities and challenges
  - a. MEMS fabrication technology applied to optics Bulk, surface and highaspect-ratio-etching micromachined structures in optics
  - b. Actuation principles and materials
  - c. Integration and packaging Monolithic integration of electronics and MEMS, Hybrid integration, bonding, and self assembly, Silicon-optical bench technology
- 2. Scaling of Optical Devices
  - a. Diffraction made simple Gaussian Beam propagation
  - b. Resolution of microscanners and Spatial Light Modulators (projection displays)
  - c. Requirements on surface quality
- 3. Micromirror Arrays
- 4. Micromirrors fabricated on Silicon-on-insulator materials

### B. Optical MEMS in Telecommunications

- 1. Fiber switch concepts and implementations
  - a. 2x2 switch
  - b. Matrix switch
  - c. 3-D switch
- 2. Implementation Challenges
  - a. Optical quality, large switches, reliability, speed, fiber alignment, packaging
- 3. Filters and gain equalizers
- 4. Dispersion Compensation
- 5. Network impact

### C. Diffractive Optical Microsystems

- 1. Design and operation of Grating Light Modulators
  - a. Displays
  - b. Free-space communication

- c. Voltage Controlled Attenuators
- d. Displacement sensors
- 2. Diffractive filters
- 3. Tunable lasers
- 4. MEMS/electronic integration

#### D. Optics and Nano-Electro-Mechanical-Systems (NEMS)

- 1. Atomic Force Microscopy
- 2. Photonic Crystals
  - a. Integrated optics
  - b. Holey fiber
- 3. 2-D Photonic Crystals
  - a. Mirrors and filters
  - b. Sensors
  - c. Photon Tunneling
- 4. MEMS surfaces and interfaces
- 5. Conclusions and Outlook